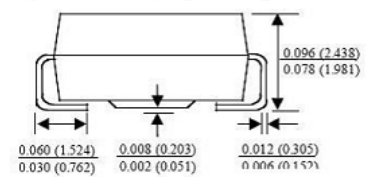
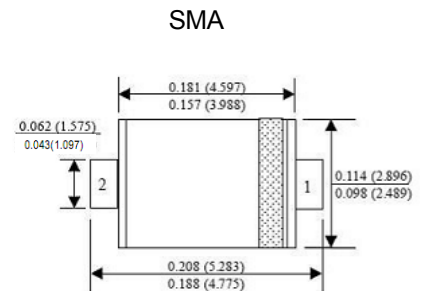


Features

- Low profile Surface Mount package
- Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- Built-in strain relief
- Low power loss, high efficiency
- For use in low voltage high frequency inverters, free wheeling, and polarity protection applications
- Guarding for overvoltage protection
- High Temp Soldering: 250°C for 10 Seconds At Terminals

Maximum Ratings

- JEDEC DO-214AC molded plastic body
- Solder plated, solderable per MILSTD750, Method 2026
- Color band denotes cathode end



(inch) mm

MCC Part Number	Device Marking	Maximum Repetitive Peak Reverse Voltage	Maximum RMS Voltage	Maximum DC Blocking Voltage
SS32	SS32	20V	14V	20V
SS33	SS33	30V	21V	30V
SS34	SS34	40V	28V	40V
SS35	SS35	50V	35V	50V
SS36	SS36	60V	42V	60V

Electrical Characteristics @ 25°C Unless Otherwise Specified

Maximum Average Forward Current	$I_{F(AV)}$	3.0A	$T_J = 25^\circ\text{C}$
Peak Forward Surge Current	I_{FSM}	100A	8.3ms, half sine
Maximum Instantaneous Forward Voltage	V_F	.50V .75V	$I_{FM} = 3.0A^{(1)}$ $T_J = 25^\circ\text{C}$
Maximum DC Reverse Current At Rated DC Blocking Voltage	I_R	.5mA 20mA 10mA	$T_J = 25^\circ\text{C}^{(1)}$ $T_J = 100^\circ\text{C}$
Typical Thermal resistance ⁽²⁾	R_{JA} R_{JL}	55°C/W 17°C/W	
Operating junction temperature range	T_J	-55 to +150°C	
Storage temperature range	T_{STG}	-55 to +150°C	

(1) Pulse test: Pulse width 300 usec, Duty cycle 1%

(2) P.C.B. mounted 0.55x0.55"(14x14mm) copper pad areas

SS32-SS36

FIG. 1 - FORWARD CURRENT DERATING CURVE

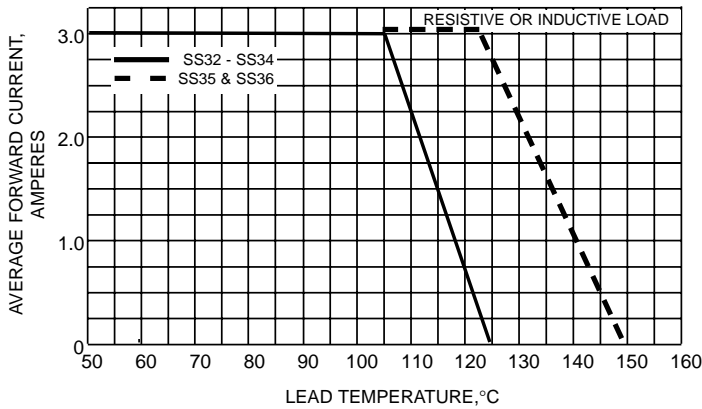


FIG. 2 - MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

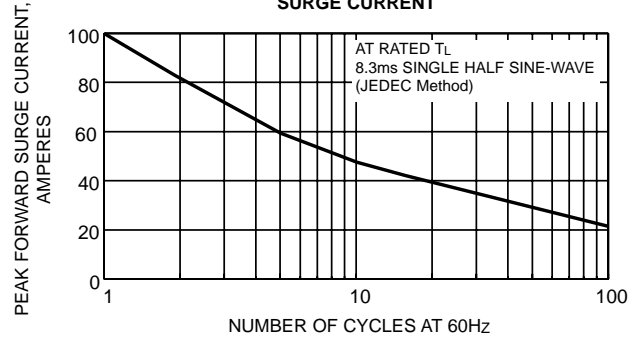


FIG. 3 - TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

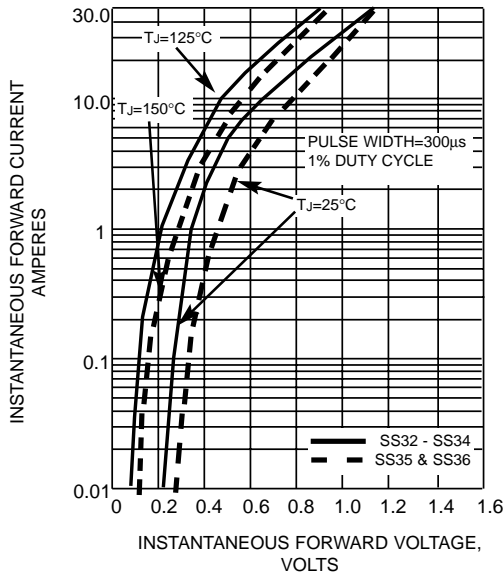


FIG. 4 - TYPICAL REVERSE CURRENT CHARACTERISTICS

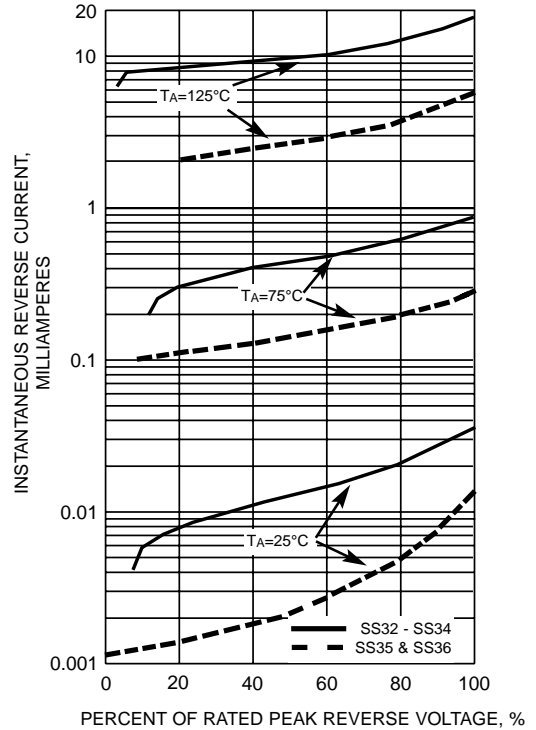


FIG. 5 - TYPICAL JUNCTION CAPACITANCE

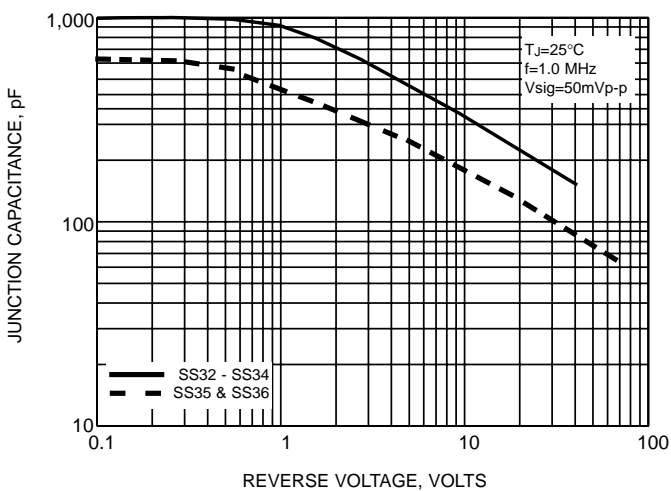


FIG. 6 - MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

